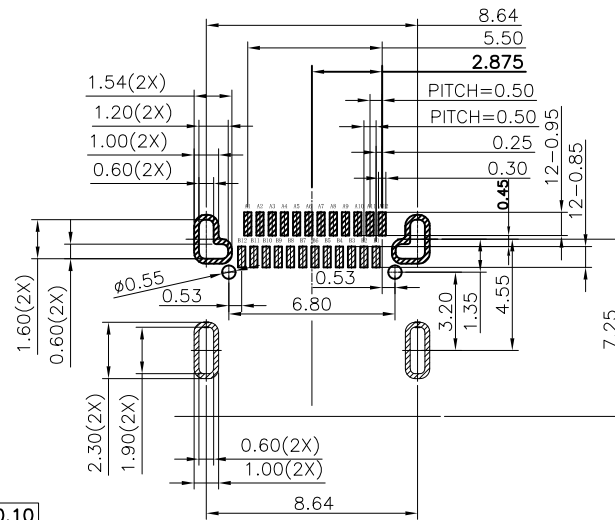
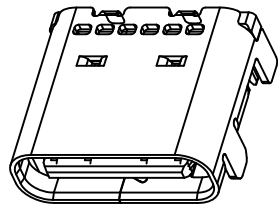
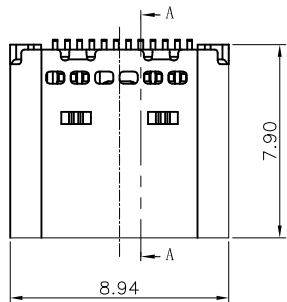




RECOMMENDED PCB LAYOUT(TOP VIEW)
THICKNESS 0.60MM:DEFAULT TOLERANCE:±0.05

NOTE:

- 1.MATERIAL SPECIFICATION:
 - 1.HOUSING:LCP
 - 2.CONTACTS:COPPER ALLOY(C1814)
 - 3.MID PLATE&EMI PLATE: STAINLESS STEEL(SUS301)
 - 4.FRONT SHELL: STAINLESS STEEL(SUS304)
 - 2.PLATING SPECIFICATION:
 - 2-1.CONTACTS:
Ni 50u" MIN. UNDER PLATED OVER ALL.
Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
 - 2-2.FRONT SHELL:
Ni 30u" MIN. UNDER PLATED OVER ALL.
 - 2-3.MID PLATE:
Ni 30u" MIN. UNDER PLATED OVER ALL.
Sn 80u"MIN. PLATED OVER ALL
 - 3.MECHANICAL PERFORMANCE,
 - 3-1.INSERTION FORCE: 0.5~2.0kgf.
 - 3-2.REMOVAL FORCE: 0.8kgf~2.0kgf.
 - 3-3.DURABILITY: 10000 CYCLES.
 - 4.ELECTRICAL PERFORMANCE,
 - 4-1. CURRENT RATING:5.0A
VOLTAGE RATING:5.0V
 - 4-2. LLCR:
VBUS & GND PINS AND OTHER PINS: 40mΩ/PIN MAX.
SHIELD: 50mΩ/MAX.
LLCR MAX. CHANGE OF ALL PINS: 10mΩ.
 - 4-3.INSULATION RESISTANCE: 100MΩ MIN
 - 4-4.DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.
 5. ENVIRONMENTAL PERFORMANCE:
OPERATING TEMPERATURE: -25°C~+85°C.
- * SIGN "X" IS IMPORTANCE DIMENSION

USB TYPE-C PIN ASSIGNMENTS

PIN NUMBER	SIGNAL NAME	PIN NUMBER	SIGNAL NAME
A1	GND	B12	GND
A2	SSTXp1	B11	SSRXp1
A3	SSTXn1	B10	SSRXn1
A4	Vbus	B9	Vbus
A5	CC1	B8	SBU2
A6	Dp1	B7	Dn2
A7	Dn1	B6	Dp2
A8	SBU1	B5	CC2
A9	Vbus	B4	Vbus
A10	SSRXn2	B3	SSTXn2
A11	SSRXp2	B2	SSTXp2
A12	GND	B1	GND

KEM 奇速科技有限公司
Qi-Speed Technology CO., LTD.

產品名稱:
PRODUCT NAME
USB C TYPE 板上双排贴片母座

單位: mm	繪圖	設計	審核	核准	料號:KUSBC0010-F001
比例:	DRAWING	DESIGNED	CHECKED BY	APPROVAL BY	PART NUMBER
公差: .X ±0.38 .XX ±0.25 .XXX ±0.13	JOHNY	JOHNY	LUKE	JAMES	圖號:KUSBC0010-F001-1 DRAWING NO
版本	修改事項	修改日期	日期: 2018/12/28		版本: REV. 0